

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Mitsuhiko Miyazaki	08/09/2011
RECEIVING PARTY DATA	
Name:	Hakko Corporation
Street Address:	4-5, Shiokusa 2-chome, Naniwa-ku
City:	Osaka
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29401364
CORRESPONDENCE DATA	
Fax Number:	(415)393-9887
Phone:	(415) 954-0200
Email:	carolyn.winter@ssd.com
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Correspondent Name:	Squire, Sanders & Dempsey (US) LLP
Address Line 1:	275 Battery Street, Suite 2600
Address Line 4:	San Francisco, CALIFORNIA 94111
ATTORNEY DOCKET NUMBER:	062649.00054
NAME OF SUBMITTER:	Song Zhu
Total Attachments: 1 source=62649_54_Assignment#page1.tif	

CH \$40.00 29401364

501668781

PATENT
 REEL: 026956 FRAME: 0579

ASSIGNMENT

For value received, I (We), Mitsuhiro MIYAZAKI, residing at c/o Hakko Corporation, 4-5, Shiokusa 2-chome, Naniwa-ku, Osaka-shi, Osaka, Japan, hereby sell, assign, and transfer to HAKKO CORPORATION, a corporation existing under the laws of Japan, located at 4-5, Shiokusa 2-chome, Naniwa-ku, Osaka-shi, Osaka, Japan, and its successors, assigns, and legal representatives, the entire right, title, and interest for all countries including the United States of America, in and to certain inventions relating to

Soldering Tip

described in an application for Letters Patent of the United States,
[X] having an oath or declaration by me/us executed on even date herewith;
[X] bearing Serial No. 29/401,364 and filed on 09/11/2011, and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I/We have full right so to do, and agree that I/We will communicate to said Company or its representatives any facts known to me/us respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

The Assignor(s) hereby authorizes and requests the attorneys of SQUIRE, SANDERS & DEMPSEY, L.L.P. (Customer No. 44955), to insert in the spaces provided above the filing date, serial number, and attorney docket number of said application if not previously inserted.

Signature Mitsuhiro Miyazaki Date 08/08/2011
Mitsuhiko MIYAZAKI